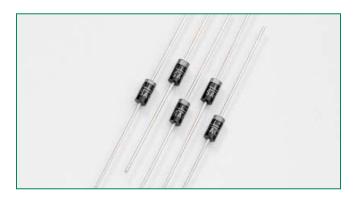
### HF RoHS

# **SAC Series**





#### **Agency Approvals**

AGENCY	AGENCY FILE NUMBER
. <b>57</b> J	E230531

# Maximum Ratings and Thermal Characteristics ( $T_a$ =25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation by 10x1000µs test waveform (Fig.1) (Note 1)	P <sub>PPM</sub>	500	W
Steady State Power Dissipation on infinite heat sink at $T_L$ =75°C (Fig. 5)	P <sub>D</sub>	3.0	W
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 175	°C

#### Note:

1. Non-repetitive current pulse , per Fig. 3 and derated above  $\rm T_{\rm A} = 25^{\rm o}C$  per Fig. 2.

#### **Description**

The SAC Series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

#### **Features**

- Halogen-Free
- RoHS compliant
- Glass passivated chip junction in DO-15 Package
- 500W peak pulse power capability at 10×1000µs waveform, repetition rate (duty cycles):0.01%
- Fast response time: typically less than 1.0ps from 0 Volts to BV min
- Excellent clamping capability
- Low incremental surge resistance

- High temperature soldering guaranteed: 260°C/40 seconds / 0.375",(9.5mm) lead length, 5 lbs., (2.3kg) tension
- Plastic package has Underwriters Laboratory Flammability classification 94V-O
- Matte Tin Lead–free plated
- Ideal for data line applications

#### **Applications**

TVS devices are ideal for the protection of I/O interfaces, V<sub>cc</sub> bus and other vulnerable circuits used in telecom, computer, industrial and consumer electronic applications.

#### **Electrical Characteristics**

Part Number	Reverse Stand off Voltage V <sub>R</sub>	Breakdown Voltage V <sub>BR</sub> (V)	Maximum Reverse Leakage I <sub>R</sub> @ V <sub>R</sub>	Maximum Clamping Voltage at I <sub>m</sub> =5.0A	Maximum Peak Pulse Current (Fig.3)	Maximum Junction Capacitance @ 0 Volts	Working Inverse Blocking Voltage	Inverse Blocking Leakage Current at I <sub>IB</sub> @ V <sub>WIB</sub>	Peak Inverse Blocking Voltage	Agency Approval
	(V)	MIN	¨(μ <b>Α</b> ) ¨	V <sub>C</sub> (V)	I <sub>PP</sub> (A)	(pF)	V <sub>WIB</sub> (V)	"(mA)	V <sub>PIB</sub> (Ŭ)	
SAC5.0	5.0	7.60	300	10.0	44.0	50	75	1.0	100	X
SAC6.0	6.0	7.90	300	11.2	41.0	50	75	1.0	100	X
SAC7.0	7.0	8.33	300	12.6	38.0	50	75	1.0	100	X
SAC8.0	8.0	8.89	100	13.4	36.0	50	75	1.0	100	X
SAC8.5	8.5	9.44	50	14.0	34.0	50	75	1.0	100	X
SAC10	10.0	11.10	5	16.3	29.0	50	75	1.0	100	X
SAC12	12.0	13.30	1	19.0	25.0	50	75	1.0	100	X
SAC15	15.0	16.70	1	23.6	20.0	50	75	1.0	100	X
SAC18	18.0	20.00	1	28.8	15.0	50	75	1.0	100	X
SAC22	22.0	24.40	1	35.4	14.0	50	75	1.0	100	X
SAC26	26.0	28.90	1	42.3	11.1	50	75	1.0	100	X
SAC30	30.0	33.30	1	48.6	10.0	50	75	1.0	100	X
SAC36	36.0	40.00	1	60.0	8.6	50	75	1.0	100	X
SAC45	45.0	50.00	1	77.0	6.8	50	150	1.0	200	X
SAC50	50.0	55.50	1	88.0	5.8	50	150	1.0	200	Χ

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#### Ratings and Characteristic Curves (Ta=25°C unless otherwise noted)

Figure 1 - Peak Pulse Power Rating Curve

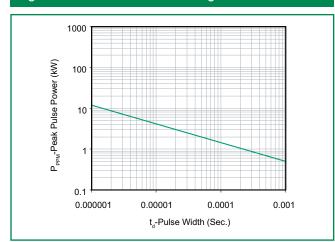


Figure 2 - Pulse Derating Curve

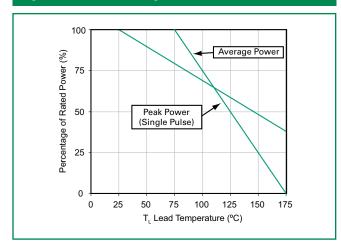
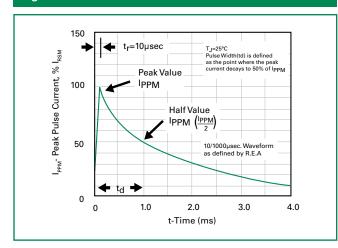
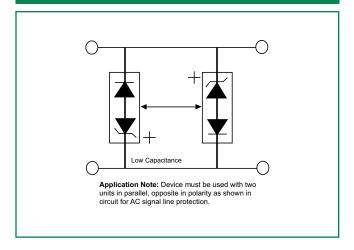


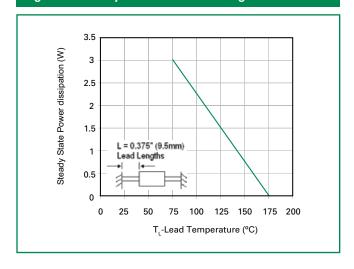
Figure 3 - Pulse Waveform



**Figure 4 - AC Line Protection Application** 



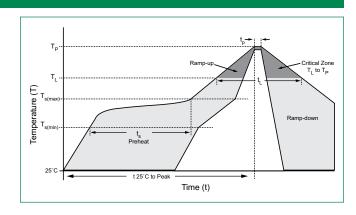
**Figure 5 - Steady State Power Derating Curve** 





#### **Soldering Parameters**

Reflow Co	ndition	Lead-free assembly	
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (min to max) (t <sub>s</sub> )	60 – 180 secs	
Average ra	amp up rate (Liquidus Temp k	3°C/second max	
T <sub>S(max)</sub> to T <sub>L</sub>	- Ramp-up Rate	3°C/second max	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
	-Time (min to max) (t <sub>s</sub> )	60 – 150 seconds	
PeakTemp	perature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C	
Time with Temperatu	in 5°C of actual peak ure (t <sub>p</sub> )	20 - 40 seconds	
Ramp-dov	vn Rate	6°C/second max	
Time 25°C	to peakTemperature (T <sub>P</sub> )	8 minutes Max.	
Do not exc	ceed	280°C	



# Flow/Wave Soldering (Solder Dipping)

Peak Temperature :	265°C	
Dipping Time :	10 seconds	
Soldering :	1 time	

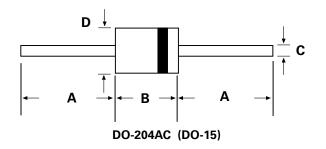
#### **Physical Specifications**

Weight	0.015oz., 0.4g			
Case	JEDEC DO-204AC (DO-15) molded plastic body over passivated junction.			
Polarity	Color band denotes the cathode except Bipolar.			
Terminal	Matte Tin axial leads, solderable per JESD22-B102D.			

#### **Environmental Specifications**

Temperature Cycle	JESD22-A104
Pressure Cooker	JESD 22-A102
High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Thermal Shock	JESD22-A106

# **Dimensions**

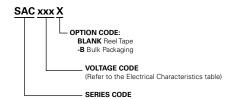


Dimensions	Inc	hes	Millimeters		
Difficusions	Min	Max	Min	Max	
А	1.000	-	25.40	-	
В	0.230	0.300	5.80	7.60	
С	0.028	0.034	0.71	0.86	
D	0.104	0.140	2.60	3.60	

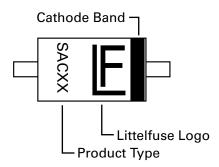
# **Transient Voltage Suppression Diodes**Axial Leaded – 500W > SAC series



#### **Part Numbering System**



#### **Part Marking System**



#### **Packaging**

Part Number	Component Package	Quantity	Packaging Option	Packaging Specification
SACxxxXX	DO-204AC	4000	Tape & Reel	EIA STD RS-296E
SACxxxXX-B	DO-204AC	1000	BULK	Littelfuse Concord Packing Spec. DM-0016

# **Schematic**

